

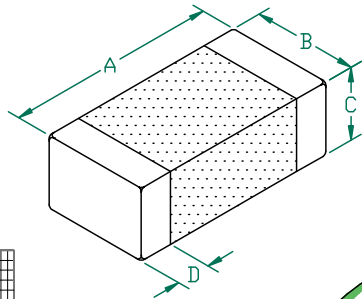


HI1206T161R-10

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

- A 3.20 [.126] ± 0.20 [.008]
- B 1.60 [.063] ± 0.20 [.008]
- C 1.60 [.063] ± 0.20 [.008]
- D 0.51 [.020] ± 0.25 [.010]

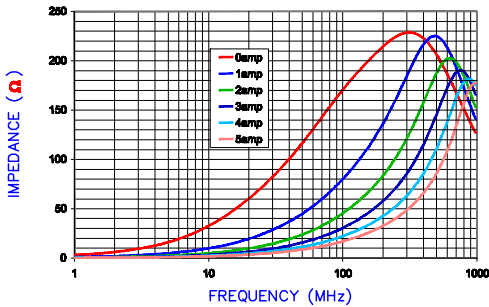


ELECTRICAL CHARACTERISTICS:			
Z @ 100MHz (Ω)	DCR (Ω)	Rated Current	
Nominal	160		
Minimum	120		
Maximum	208	0.018	6000 mA

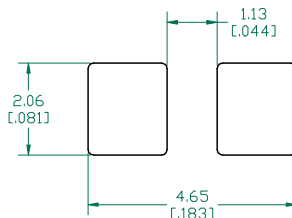
- NOTES: UNLESS OTHERWISE SPECIFIED
- TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 2000 PCS/REEL, EMBOSSED PLASTIC TAPE.
 - COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
 - TERMINATION FINISH IS 100% TIN.



Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS

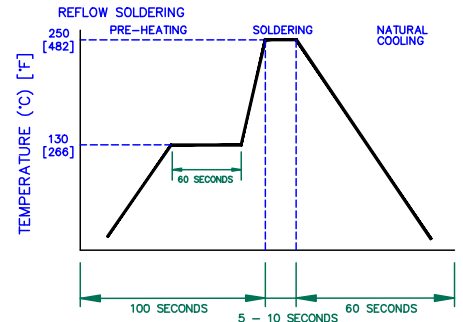


LAND PATTERNS FOR REFLOW SOLDERING

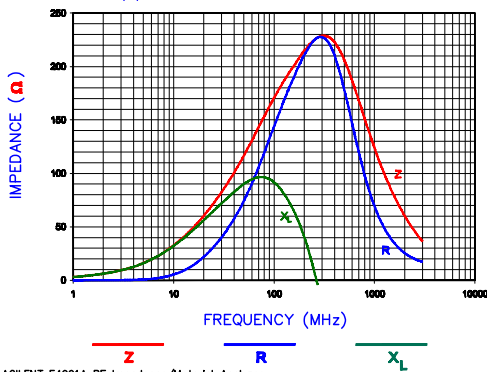


(For wave soldering, add 0.762 [0.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS



|Z|, R, AND X vs. FREQUENCY



AGILENT E4991A RF Impedance/Material Analyzer
HP 16194A Test Fixture. TEST REF. 3185

DIMENSIONS ARE IN mm [INCHES]				This print is the property of Laird Tech. and is loaned in confidence subject to return upon request and with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.	
F	UPDATE COMPANY LOGO	10/09/08	TMB	PROJECT/PART NUMBER: HI1206T161R-10	
E	ADD EMBOSSED PLASTIC TAPE TO NOTE 1	01/19/07	JRK		
D	CHANGE C DIMENSION	01/15/07	JRK		
C	CHG REEL QTY ADD ROHS SYMBOL	08/28/06	JRK		
B	CHANGE MAXIMUM IMPEDANCE FROM 200	01/11/05	JRK	DATE: 01/13/04	SCALE: NTS
A	ORIGINAL DRAFT	01/13/04	JRK	CAD # HI1206T161R-10-F	TOOL # -
REV	DESCRIPTION	DATE	INT	SHEET: 2 of 2	

